



MEMORANDUM CIRCULAR NO. 14-005 III
Series of 2014

TO : All Concerned


SUBJECT : Due Date for Payment of the Filing Fee of Mailed Invention (Direct Route), Utility Model (Direct Route), Industrial Design and Layout-Design (Topography) of Integrated Circuit Applications

DATE : August 8, 2014

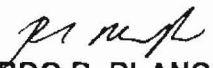
For invention (direct route), utility model (direct route), industrial design and layout-design (topography) of integrated circuit applications filed through mail, the prescribed time limit of one (1) month from the filing date of the application for payment of the filing fee provided for in the Implementing Rules and Regulations shall be adjusted so that it shall be reckoned from the date of physical receipt by the IPOPHL duty officer or, in those cases where the application is mailed to the Intellectual Property Satellite Office (IPSO), from the date of physical receipt by the IPSO officer, regardless of the filing date.


This Circular provides flexibility and addresses the delays in the postal service.

For your guidance.


EUFANIO M. EVASCO
Director, Bureau of Patents

Noted:


RICARDO R. BLANCAFLOR
Director General

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